

Cree® XLamp® XP-E LEDs



PRODUCT DESCRIPTION

The XLamp® XP-E LED combines the proven lighting-class performance and reliability of the XLamp XR-E LED in a package with 80% smaller footprint. The XLamp XP-E LED continues Cree's history of innovation in LEDs for lighting applications with wide viewing angle, symmetrical package, unlimited floor life and electrically neutral thermal path.

Cree XLamp LEDs bring high performance and quality of light to a wide range of lighting applications, including color-changing, portable and personal, outdoor, indoor-directional, transportation, stage and studio, commercial, horticulture and emergency-vehicle lighting.

FEATURES

- Available in white, outdoor white, 80-CRI, 85-CRI and 90-CRI white, royal blue, blue, green, amber, red-orange, red, photo red & far red
- · Maximum drive current: up to 1 A
- Low thermal resistance: as low as 8 °C/W
- Maximum junction temperature: 150 °C
- Wide viewing angle: 115°-130°
- Unlimited floor life at ≤ 30 °C/85% RH
- Reflow solderable JEDEC
 J-STD-020C compatible
- Electrically neutral thermal path
- · RoHS- and REACh-compliant
- UL® recognized component (E349212)



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CHARACTERISTICS

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point - white, royal blue, blue	°C/W		9	
Thermal resistance, junction to solder point - green	°C/W		15	
Thermal resistance, junction to solder point - amber	°C/W		10	
Thermal resistance, junction to solder point - red-orange, red, photo red, far red	°C/W		8	
Viewing angle (FWHM) - white	degrees		115	
Viewing angle (FWHM) - royal blue, blue, green, amber, red-orange, red, photo red, far red	degrees		130	
Temperature coefficient of voltage - white	mV/°C		-3.0	
Temperature coefficient of voltage - royal blue, blue	mV/°C		-3.3	
Temperature coefficient of voltage - green	mV/°C		-3.8	
Temperature coefficient of voltage - amber	mV/°C		-1.2	
Temperature coefficient of voltage - red-orange, red	mV/°C		-1.8	
Temperature coefficient of voltage - photo red	mV/°C		-3.0	
Temperature coefficient of voltage - far red	mV/°C		-1.0	
ESD withstand voltage (HBM per Mil-Std-883D) - white, royal blue, blue, green	V			8000
ESD classification (HBM per Mil-Std-883D) - amber, red-orange, red, photo red, far red			Class 2	
DC forward current - white, royal blue, blue, green, photo red, far red	mA			1000
DC forward current - amber	mA			500
DC forward current - red-orange, red	mA			700
Reverse voltage	V			5
Forward voltage (@ 350 mA) - white	V		3.05	3.9
Forward voltage (@ 350 mA) - royal blue, blue	V		3.1	3.9
Forward voltage (@ 350 mA) - green	V		3.3	3.9
Forward voltage (@ 350 mA) - amber, red-orange, red, photo red	V		2.1	2.5
Forward voltage (@ 350 mA) - far red	V		1.9	2.4
Forward voltage (@ 500 mA) - amber	V		2.3	
Forward voltage (@ 700 mA) - white	V		3.3	
Forward voltage (@ 700 mA) - red-orange, red, photo red	V		2.3	
Forward voltage (@ 700 mA) - far red	V		2.1	
Forward voltage (@ 1000 mA) - white, royal blue, blue	V		3.5	
Forward voltage (@ 1000 mA) - green	V		3.8	
Forward voltage (@ 1000 mA) - photo red	V		2.5	
Forward voltage (@ 1000 mA) - far red	V		2.25	
LED junction temperature	°C			150



FLUX CHARACTERISTICS - WHITE (T, = 25 °C)

The following table provides several base order codes for XLamp XP-E LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XP LED Family Binning and Labeling document.

Color	CCT Range			minous Flux 350 mA	Order Code	
	Min.	Max.	Group	Flux (lm)		
			Q4	100	XPEWHT-L1-0000-00C01	
01.\\/\ -:4-	F000 K	10,000 1/	Q5	107	XPEWHT-L1-0000-00D01	
Cool White	5000 K	10,000 K	R2	114	XPEWHT-L1-0000-00E01	
			R3	122	XPEWHT-L1-0000-00F01	
			Q4	100	XPEWHT-01-0000-00CC2	
Outdoor	4000 K	5300 K	Q5	107	XPEWHT-01-0000-00DC2	
White	4000 K	3300 K	R2	114	XPEWHT-01-0000-00EC2	
			R3	122	XPEWHT-01-0000-00FC2	
				Q3	93.9	XPEWHT-L1-0000-00BE4
Neutral White	3700 K	5300 K	Q4	100	XPEWHT-L1-0000-00CE4	
			Q5	107	XPEWHT-L1-0000-00DE4	
80-CRI	2600 K	4300 K	P4	80.6	XPEWHT-H1-0000-009E7	
White	2000 K	4300 K	Q2	87.4	XPEWHT-H1-0000-00AE7	
			P4	80.6	XPEWHT-L1-0000-009E7	
Warm White	2600 K	3700 K	Q2	87.4	XPEWHT-L1-0000-00AE7	
			Q3	93.9	XPEWHT-L1-0000-00BE7	
			N4	62.0	XPEWHT-P1-0000-006E7	
85-CRI	060016	0000 1/	P2	67.2	XPEWHT-P1-0000-007E7	
White	2600 K	3200 K	P3	73.9	XPEWHT-P1-0000-008E7	
			P4	80.6	XPEWHT-P1-0000-009E7	
			N4	62.0	XPEWHT-U1-0000-006E7	
90-CRI White	2600 K	3200 K	P2	67.2	XPEWHT-U1-0000-007E7	
			P3	73.9	XPEWHT-U1-0000-008E7	

Notes:

- Cree maintains a tolerance of ±7% on flux and power measurements, ±0.005 on chromaticity (CCx, CCy) measurements and ±2 on CRI measurements. See the Measurements section (page 19).
- Typical CRI for Cool White (5000 K 10,000 K CCT) is 70.
- Typical CRI for Neutral White (3700 K 5300 K CCT) is 75.
- Typical CRI for Outdoor White (4000 K 5300 K CCT) is 70.
- Typical CRI for Warm White (2600 K 3700 K CCT) is 80.
- Minimum CRI for 80-CRI White is 80.
- Minimum CRI for 85-CRI White is 85.
- Minimum CRI for 90-CRI White is 90.



FLUX CHARACTERISTICS - COLOR (T_J = 25 °C)

The following tables provide several base order codes for XLamp XP-E LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XP LED Family Binning and Labeling document.

	Do	minant Wav	elength Rar	ige	Minimum	n Radiant Flux			
Color	Min.		Max.		(mW)	@ 350 mA	Order Code		
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (mW)			
					14	350	XPEROY-L1-0000-00901		
Royal Blue	D3	450	D5	465	15	425	XPEROY-L1-0000-00A01		
					16	500	XPEROY-L1-0000-00B01		

	Do	minant Wav	elength Rar	ige	Minimum	Luminous Flux				
Color	Min.		Max.		(lm)	@ 350 mA	Order Code			
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)				
								K2	30.6	XPEBLU-L1-0000-00Y01
Blue	В3	465	В6	485	K3	35.2	XPEBLU-L1-0000-00Z01			
					M2	39.8	XPEBLU-L1-0000-00201			

	Dominant Wavelength Range			Minimum	Luminous Flux						
Color	Min.		Max.		(lm) @ 350 mA		Order Code				
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)					
				G4 535	P4	80.6	XPEGRN-L1-0000-00901				
					Q2	87.4	XPEGRN-L1-0000-00A01				
Green	G2	520	G4		Q3	93.9	XPEGRN-L1-0000-00B01				
Green	G2	320			Q4	100	XPEGRN-L1-0000-00C01				
				Q5	107	XPEGRN-L1-0000-00D01					
									R2	114	XPEGRN-L1-0000-00E01

Note: Cree maintains a tolerance of $\pm 7\%$ on flux and power measurements and ± 1 nm on dominant wavelength measurements. See the Measurements section (page 19).



FLUX CHARACTERISTICS - COLOR (T $_{\rm J}$ = 25 °C) - CONTINUED

	Do	Dominant Wavelength Range				Luminous Flux								
Color	M	Min.		Max.		@ 350 mA	Order Code							
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)								
			A3 595				M3	45.7	XPEAMB-L1-0000-00301					
							N2	51.7	XPEAMB-L1-0000-00401					
													N3	56.8
Amber	A2	585		595	595	N4	62.0	XPEAMB-L1-0000-00601						
						P2	67.2	XPEAMB-L1-0000-00701						
								P3	73.9	XPEAMB-L1-0000-00801				
					P4	80.6	XPEAMB-L1-0000-00901							

	Dominant Wavelength Range			Minimum	Luminous Flux			
Color	Min.		Min. Max		(lm) @ 350 mA		Order Code	
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)		
			04			N3	56.8	XPERDO-L1-0000-00501
				N4 62.0 P2 67.2 P3 73.9	62.0	XPERDO-L1-0000-00601		
Red-	03	610			P2	67.2	XPERDO-L1-0000-00701	
Orange	03	610			P3	73.9	XPERDO-L1-0000-00801	
					P4	80.6	XPERDO-L1-0000-00901	
					Q2	87.4	XPERDO-L1-0000-00A01	

	Dominant Wavelength Range			Minimum	Luminous Flux				
Color	Min.		nin. Max.		(lm) @ 350 mA		Order Code		
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)			
			R3		M3	45.7	XPERED-L1-0000-00301		
					N2 51.7	51.7	XPERED-L1-0000-00401		
Red	R2	620		DO	DO	630	N3	N3 56.8 XPERED-L1-0	XPERED-L1-0000-00501
Reu	ΚZ	020		030	N4	62.0	XPERED-L1-0000-00601		
				P2	67.2	XPERED-L1-0000-00701			
					P3	73.9	XPERED-L1-0000-00801		

Note: Cree maintains a tolerance of $\pm 7\%$ on flux and power measurements and ± 1 nm on dominant wavelength measurements. See the Measurements section (page 19).



FLUX CHARACTERISTICS - COLOR (T $_{\rm J}$ = 25 °C) - CONTINUED

	Peak Wavelength Range				Minimum Radiant Flux				
Color	Min.		Ma	ax.	(mW) @ 350 mA		(mW) @ 350 mA		Order Code
	Group	PWL (nm)	Group	PWL (nm)	Group	Flux (mW)			
Photo	P2	650	P5	670	13	300	XPEPHR-L1-0000-00801		
Red	PZ	650	Po	670	14	350	XPEPHR-L1-0000-00901		

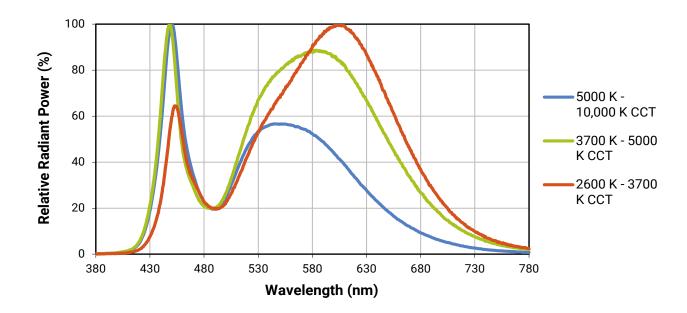
	Peak Wavel		avelength Range			n Radiant Flux			
Color	Min.		Max.		(mW) @ 350 mA		(mW) @ 350 mA		Order Code
	Group	PWL (nm)	Group	PWL (nm)	Group	Flux (mW)			
						10	175	XPEFAR-L1-0000-00501	
Far Red	F2	720	F5	740	11	210	XPEFAR-L1-0000-00601		
					12	250	XPEFAR-L1-0000-00701		

Note: Cree maintains a tolerance of $\pm 7\%$ on flux and power measurements and ± 1 nm on dominant wavelength measurements. See the Measurements section (page 19).

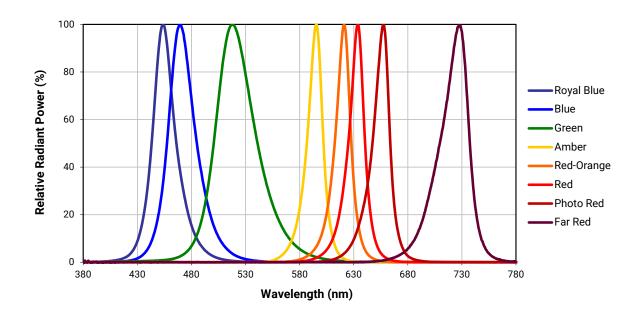


RELATIVE SPECTRAL POWER DISTRIBUTION

White

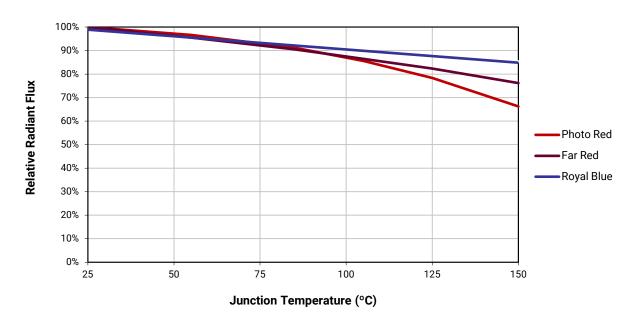


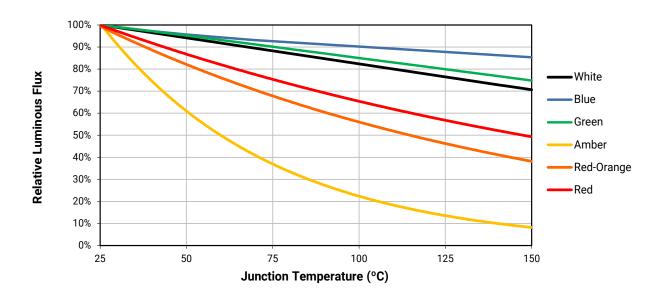
Color





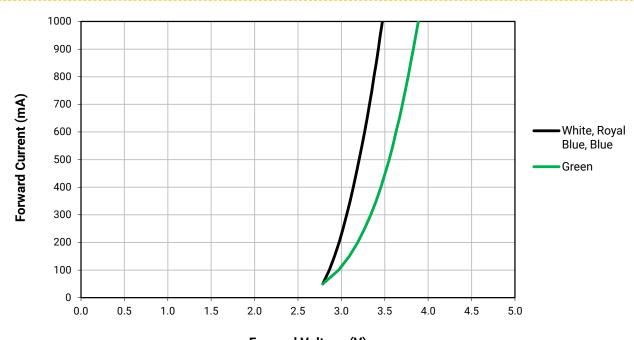
RELATIVE FLUX VS. JUNCTION TEMPERATURE (I_F = 350 mA)



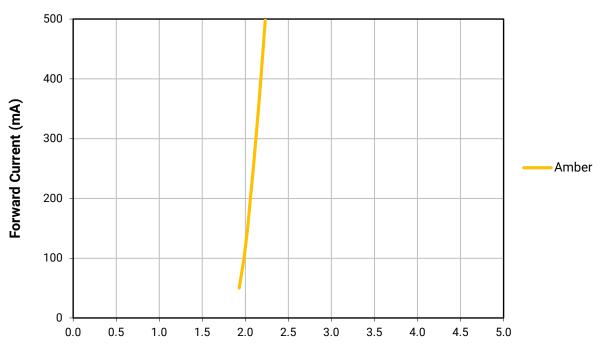




ELECTRICAL CHARACTERISTICS (T₁ = 25 °C)



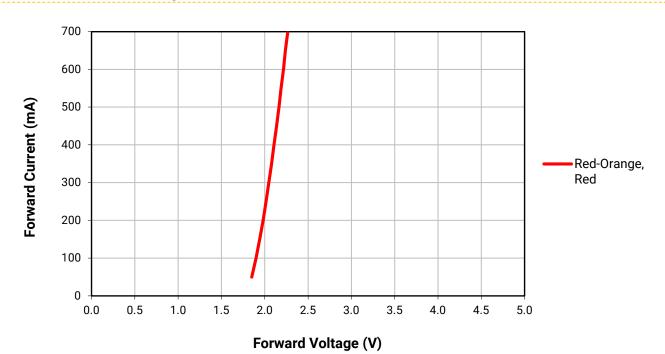


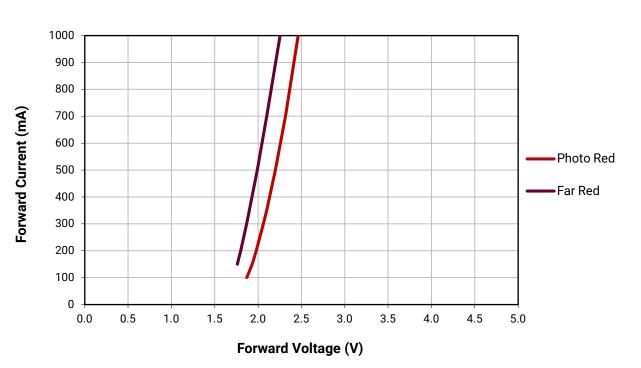


Forward Voltage (V)



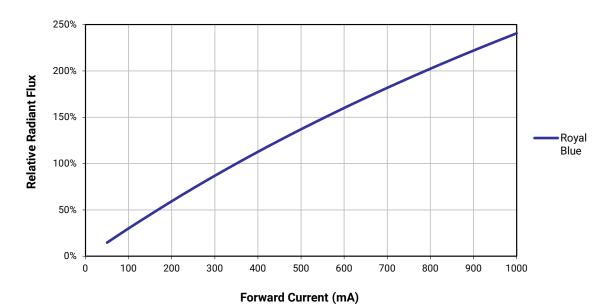
ELECTRICAL CHARACTERISTICS (T, = 25 °C) - CONTINUED

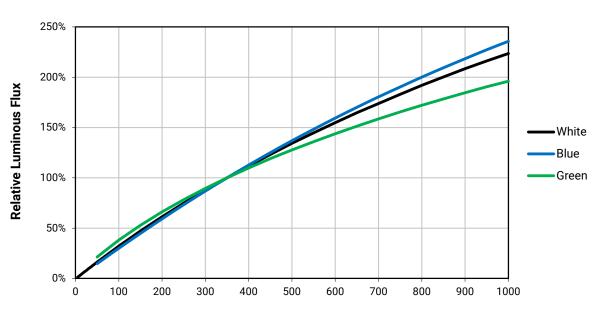






RELATIVE FLUX VS. CURRENT (T, = 25 °C)

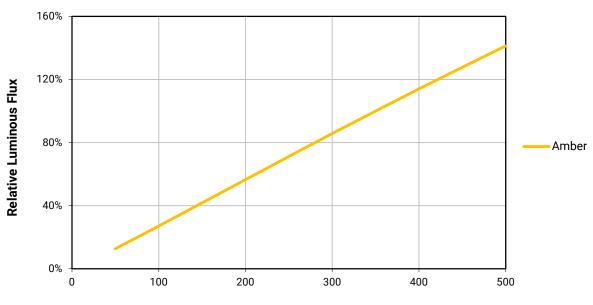




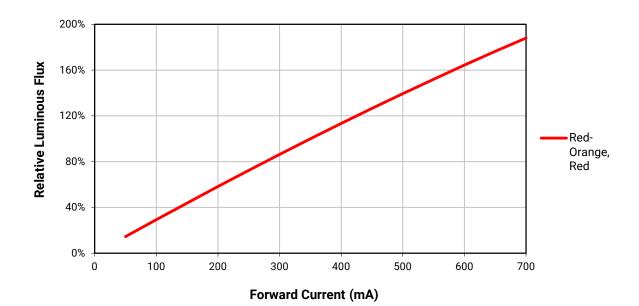
Forward Current (mA)



RELATIVE FLUX VS. CURRENT ($T_J = 25 \, ^{\circ}\text{C}$) - CONTINUED

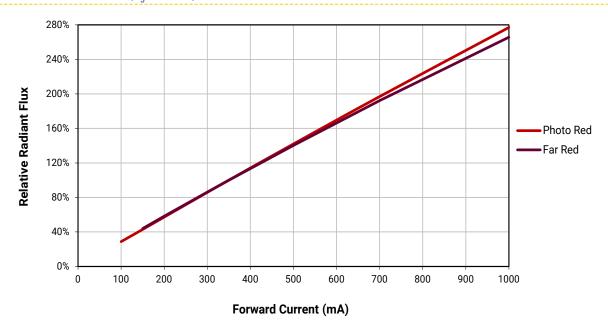






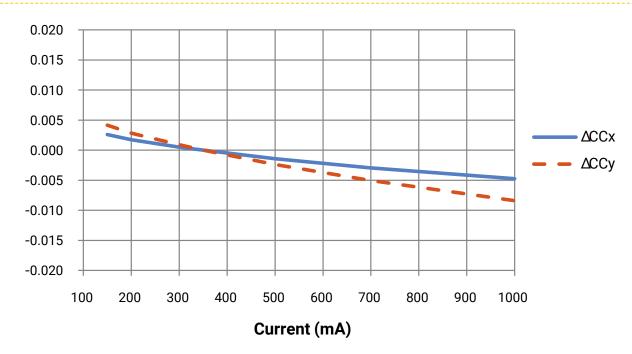


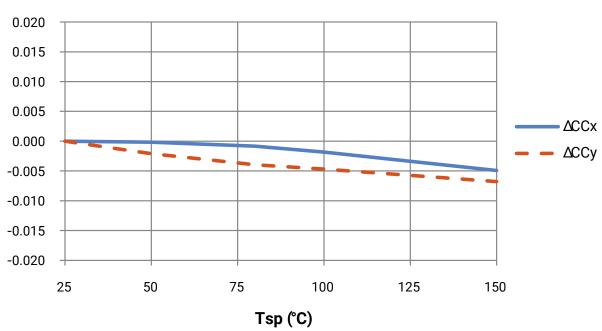
RELATIVE FLUX VS. CURRENT (T_J = 25 °C) - CONTINUED





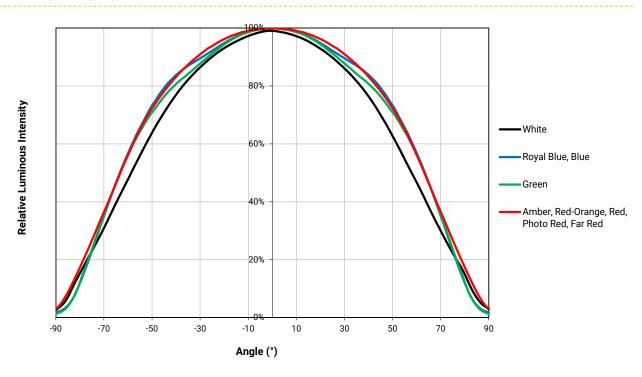
RELATIVE CHROMATICITY VS. CURRENT AND TEMPERATURE - WARM WHITE







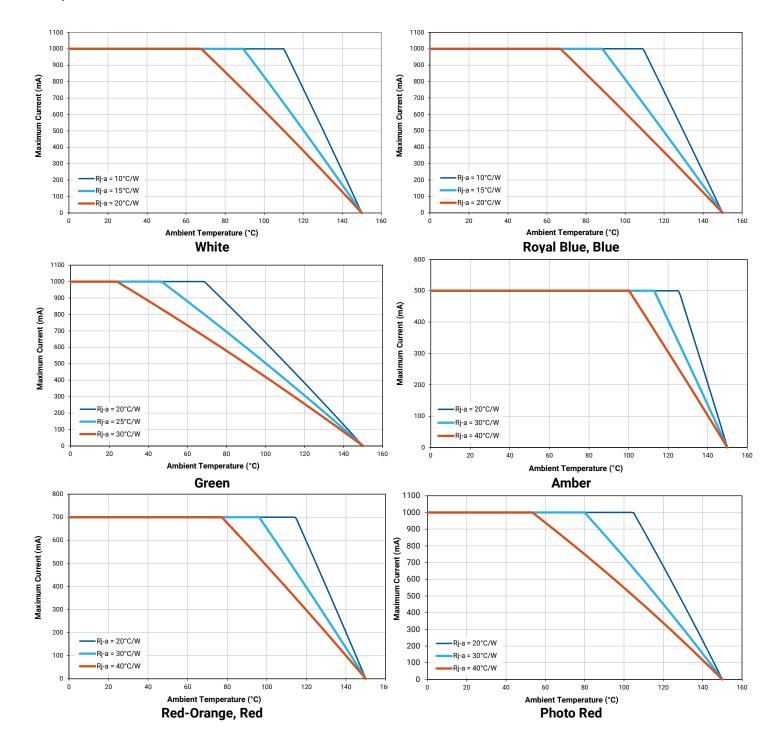
TYPICAL SPATIAL DISTRIBUTION





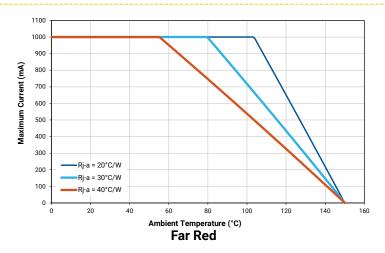
THERMAL DESIGN

The maximum forward current is determined by the thermal resistance between the LED junction and ambient. It is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.





THERMAL DESIGN - CONTINUED

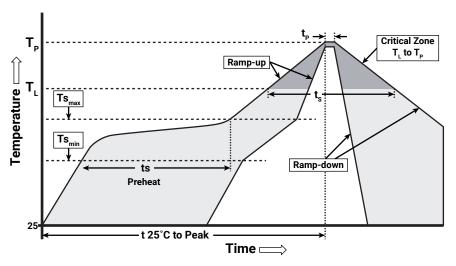




REFLOW SOLDERING CHARACTERISTICS

In testing, Cree has found XLamp XP-E LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of the solder paste used.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



IPC/JEDEC J-STD-020C

Profile Feature	Lead-Free Solder
Average Ramp-Up Rate (Ts _{max} to Tp)	1.2 °C/second
Preheat: Temperature Min (Ts _{min})	120 °C
Preheat: Temperature Max (Ts _{max})	170 °C
Preheat: Time (ts _{min} to ts _{max})	65-150 seconds
Time Maintained Above: Temperature (T _L)	217 °C
Time Maintained Above: Time (t _L)	45-90 seconds
Peak/Classification Temperature (Tp)	235 - 245 °C
Time Within 5 °C of Actual Peak Temperature (tp)	20-40 seconds
Ramp-Down Rate	1 - 6 °C/second
Time 25 °C to Peak Temperature	4 minutes max.

Note: All temperatures refer to topside of the package, measured on the package body surface.



NOTES

Measurements

The luminous flux, radiant power, chromaticity and CRI measurements in this document are binning specifications only and solely represent product measurements as of the date of shipment. These measurements will change over time based on a number of factors that are not within Cree's control and are not intended or provided as operational specifications for the products. Calculated values are provided for informational purposes only and are not intended as specifications.

Lumen Maintenance

Cree now uses standardized IES LM-80-08 and TM-21-11 methods for collecting long-term data and extrapolating LED lumen maintenance. For information on the specific LM-80 data sets available for this LED, refer to the public LM-80 results document.

Please read the Long-Term Lumen Maintenance application note for more details on Cree's lumen maintenance testing and forecasting. Please read the Thermal Management application note for details on how thermal design, ambient temperature, and drive current affect the LED junction temperature.

Moisture Sensitivity

Cree recommends keeping XLamp LEDs in the provided, resealable moisture-barrier packaging (MBP) until immediately prior to soldering. Unopened MBPs that contain XLamp LEDs do not need special storage for moisture sensitivity.

Once the MBP is opened, XLamp XP-E LEDs may be stored as MSL 1 per JEDEC J-STD-033, meaning they have unlimited floor life in conditions of \leq 30 °C/85% relative humidity (RH). Regardless of the storage condition, Cree recommends sealing any unsoldered LEDs in the original MBP.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree representative or from the Product Documentation sections of www.cree.com.

REACh Compliance

REACh substances of very high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a Cree representative to insure you get the most up-to-date REACh SVHC Declaration. REACh banned substance information (REACh Article 67) is also available upon request.

UL® Recognized Component

Level 4 enclosure consideration. The LED package or a portion thereof has been investigated as a fire and electrical enclosure per ANSI/ UL 8750.



NOTES - CONTINUED

Vision Advisory

WARNING: Do not look at an exposed lamp in operation. Eye injury can result. For more information about LEDs and eye safety, please refer to the LED Eye Safety application note.

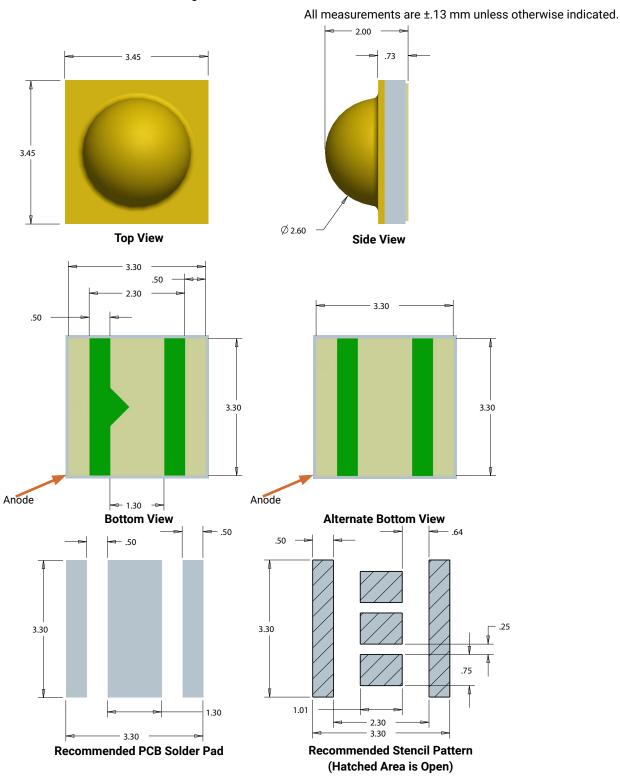
Intellectual Property

For remote phosphor applications, a separate license to certain Cree patents is required.



MECHANICAL DIMENSIONS ($T_A = 25$ °C)

Thermal vias, if present, are not shown on these drawings.

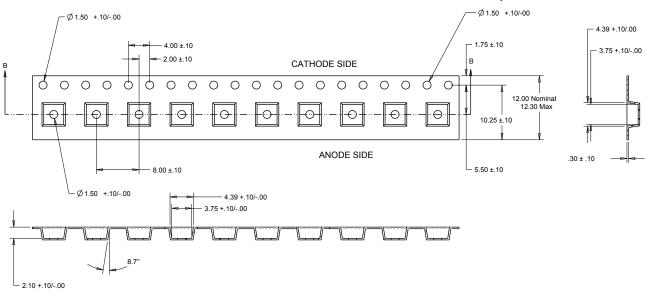


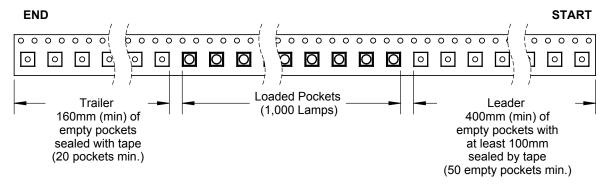


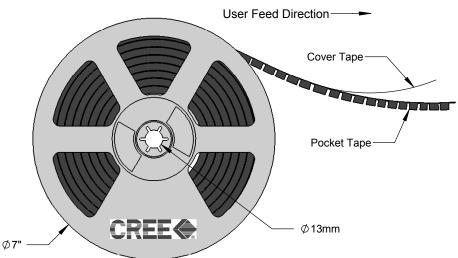
TAPE AND REEL

All Cree carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.

Except as noted, all dimensions in mm.





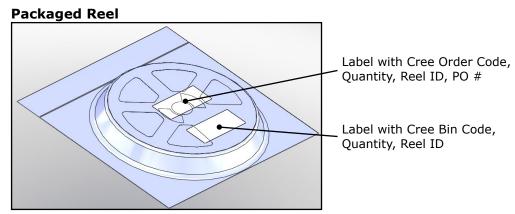


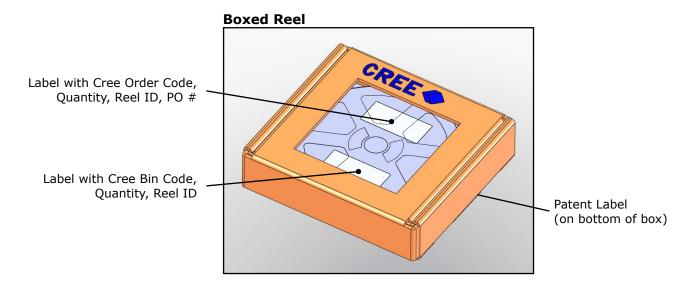


PACKAGING

Unpackaged Reel Label with Cree Bin Code,

Quantity, Reel ID







Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов:
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001:
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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